

- Low dark current
- Low capacitance, high-speed response
- Wide directivity

Optical switchs

Optical measurement equipment

# Structure

Parameter	Specification	Unit
Photosensitive area	$0.88 \times 0.88$	mm
Package	TO-18	-
Window material	Epoxy resin	-

# - Absolute maximum ratings (Ta=25 °C)

Parameter	Symbol	Condition	Value	Unit
Reverse voltage	Vr		30	V
Operating temperature	Topr	No dew condensation*1	-30 to +85	°C
Storage temperature	Tstg	No dew condensation*1	-30 to +100	°C

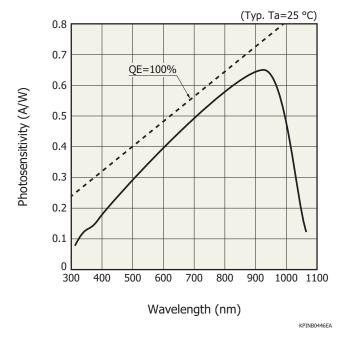
\*1: When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product surface may cause deterioration in characteristics and reliability. Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product

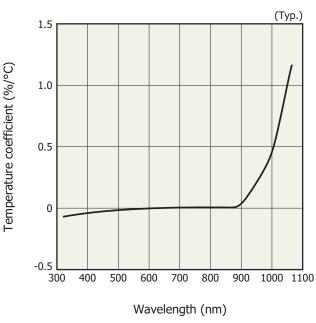
within the absolute maximum ratings.

# Electrical and optical characteristics (Ta=25 °C)

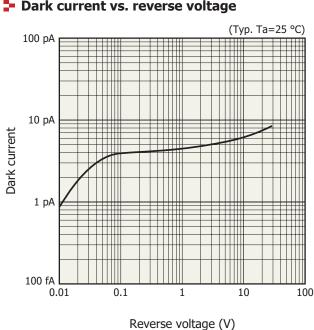
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Spectral response range	λ		-	320 to 1060	-	nm
Peak sensitivity wavelength	λр		-	920	-	nm
Photosensitivity	S	λ=870 nm	-	0.63	-	A/W
Short circuit current	Isc	2856 K, 100 <i>lx</i>	1.2	1.8	-	μA
Dark current	Id	VR=10 V	-	0.01	10	nA
Temperature coefficient of ID	ΔTid		-	1.15	-	times/°C
Cutoff frequency	fc	VR=10 V, RL=50 Ω λ=830 nm, -3 dB	-	80	-	MHz
Terminal capacitance	Ct	VR=10 V, f=1 MHz	-	5	-	pF

# Spectral response



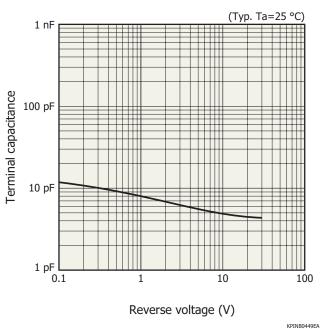


KPINB0447EA



Dark current vs. reverse voltage

Terminal capacitance vs. reverse voltage



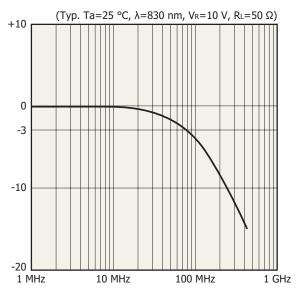
### Photosensitivity temperature characteristics



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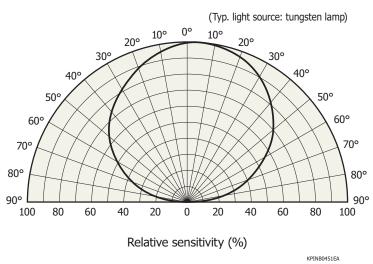


Relative output (dB)

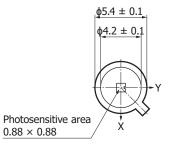


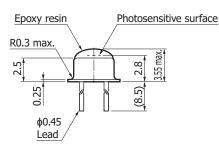
Frequency

Directivity



# Dimensional outline (unit: mm)







Case connection



Tolerance unless otherwise noted:  $\pm 0.2$ Distance from photosensitivity area center to base center  $-0.12 \le X \le +0.12$  $-0.12 \le Y \le +0.12$ 

KPINB0450EA

KPINA0126EA



#### Standard packing specification

Bagged (polyethylene bag) 1000 pcs max./bag

#### Recommended soldering condition

· Solder temperature: 260 °C max. (10 s or less, once)

Solder the leads at a point at least 1 mm away from the package body.

Note: When you set soldering condition, check that problems do not occur in the product by testing out the condition in advance.

# Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- Disclaimer
- Metal, ceramic, plastic package products

Technical information

· Si photodiodes / Technical note

Information described in this material is current as of February 2021.

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